

In the Claims(Clean version)

WSB ~~cont'd~~
4. The semiconductor cassette reducer of claim 1, wherein a base to tip distance of the first substantially U-shaped plate is less than an interior depth of a front opening unified pod.

WSB ~~cont'd~~
18. The semiconductor cassette reducer of claim 14, wherein a base to tip distance of the first substantially U-shaped plate is less than a diameter of wafer designed for a front opening unified pod.